

August 20, 2021

PCN

Change of packaging of B82732F frame core chokes

To standardize packaging of EPCOS frame core chokes and to increase stability during transportation, packaging will be changed from polystyrene tray to blister tray. The packing unit (PU) will be increased and the minimum order quantity (MOQ) will be changed accordingly.

Affected products

Ordering code
B82732F*

Comparison of previous and new packaging

Ordering code	Previous	New
B82732F*	Polystyrene tray in cardboard box	Blister tray in cardboard box
	PU: 448 pieces	PU: 770 pieces
	MOQ: 448 pieces	MOQ: 770 pieces

More details see annex.

Scheduled date of change: December 1, 2021

Estimated date of first deliveries: December 1, 2021

Enclosure PCN (ID No. MAG-693300721)

Detailed information of previous and new packaging

Contact Jessan Zhong, MAG TF T PM, Hongqi

Customers are asked to address inquiries directly to their sales contacts.

TDK Electronics AG

Rosenheimer Strasse 141 e, 81671 Munich · Post: P.O.Box 80 17 09, 81617 Munich, Germany
 Headquarters: Munich · Commercial register of the local court (Amtsgericht): Munich HRB 127250
 Chairman of the Supervisory Board: Dr. Werner Faber
 Management Board: Joachim Zichlarz, Chairman · Joachim Thiele · Dr. Werner Lohwasser
www.tdk-electronics.tdk.com

Inductors

Internal / External

210820IN1e

Product / Process Change Notification

1. ID No. MAG-693300721		2. Date of announcement August 20, 2021	
3. Product / product group Frame core chokes	Old ordering code B82732F*	New ordering code No Change	Customer part number n.a.
4. Description of change Packaging will be changed from polystyren tray to blister tray. The number of products per packing unit will be increased as follows: B82732F* from 448 to 770 pcs. Consequently the minimum order quantity will also be changed accordingly (see annex).			
5. Effect on the product or for the customer (benefit, quality, specification, lead time) Harmonization of package for the product families. Better environmental impact as new packaging materials can be recycled			
6. Quality assurance measures / risk assessment Qualification for blister trays of this FC choke family was done.			
7. Scheduled date of change December 1, 2021			
8. Estimated date of first delivery of changed product December 1, 2021 If TDK Electronics AG does not receive notification to the contrary within a period of 10 weeks, TDK Electronics AG assumes that the customer agrees to the change. <input checked="" type="checkbox"/> For an interim period we cannot rule out that old as well as new products will be shipped. <input type="checkbox"/> Future shipments can consist of old and new products as the new changed product is used as an alternative to the old product.			
Quality Management Name Wolfgang Woitsch, 2021-07-30		Signature Signed Woitsch	
Product Marketing Name Jessan Zhong Tel. +86 756 6828853 E-mail jessan.zhong@tdk-electronics.tdk.com		Signature Signed Jessan Zhong	
Customer feedback			
Customer acknowledgement		Signature	

Annex to UPtoDATE 210820IN1 of August 20, 2021 / Change of packaging of B82732F frame core chokes

Illustration of previous and new packages



Picture 1: Previous package
Polystyrene tray in cardboard box



Picture 2: New package
Blister tray in cardboard box

Part and packaging details

Series	Ordering code	Previous				New			
		Polystyrene (pcs/trays)	Trays / cardboard box	Packing unit (pcs/bcardboard box)	Cardboard box size (L*W*H)	Polystyrene (pcs/trays)	Trays / cardboard box	Packing unit (pcs/bcardboard box)	Cardboard box size (L*W*H)
B82732F*	B82732F2162B001	112	4	448	365x275x175 mm	55	14	770	430x315x200 mm
	B82732F2132B001	112	4	448	365x275x175 mm	55	14	770	430x315x200 mm
	B82732F2901B001	112	4	448	365x275x175 mm	55	14	770	430x315x200 mm
	B82732F2801B001	112	4	448	365x275x175 mm	55	14	770	430x315x200 mm
	B82732F2701B001	112	4	448	365x275x175 mm	55	14	770	430x315x200 mm
	B82732F2601B001	112	4	448	365x275x175 mm	55	14	770	430x315x200 mm
	B82732F2451B001	112	4	448	365x275x175 mm	55	14	770	430x315x200 mm